PC367N Series

Mini-flat Package High CMR, Low Input Current **Type Photocoupler**



Description

PC367N contains an IRED optically coupled to a phototransistor.

It is packaged in a 4-pin mini-flat.

Low input current type.

Input-output isolation voltage(rms) is 3.75kV.

Collector-emitter voltage is 80V (*) and CTR is

100% to 500% at input current of 0.5mA.

Features

- 1. 4-pin Mini-flat package
- 2. Double transfer mold package (Ideal for Flow Soldering)
- 3. Low input current type (I_F=0.5mA)
- 4. High collector-emitter voltage (V_{CEO} : 80V^(*))
- 5. High noise immunity due to high common mode rejection voltage (CMR : MIN. 10kV/µs)
- 6. High isolation voltage between input and output $(V_{iso(rms)}: 3.75kV)$

(*) Up to Date code "P9" (September 2002) V_{CEO} : 70V.

Agency approvals/Compliance

- 1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. PC367)
- 2. Package resin : UL flammability grade (94V-0)

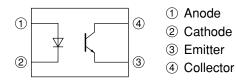
Applications

- 1. Programmable controllers
- 2. Facsimiles
- 3. Telephones

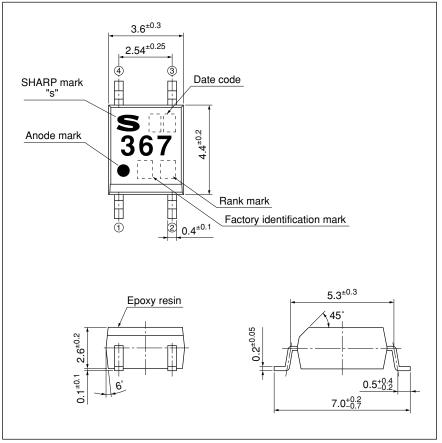
Notice The content of data sheet is subject to change without prior notice. In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that may occur in equipment using any SHARP devices shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device.



Internal Connection Diagram



■ Outline Dimensions



Product mass : approx. 0.1g

(Unit : mm)



Date code (2 digit)

	1st o	digit		2nd digit			
	Year of p	roduction		Month of production			
A.D.	Mark	A.D	Mark	Month	Mark		
1990	A	2002	Р	January	1		
1991	В	2003	R	February	2		
1992	С	2004	S	March	3		
1993	D	2005	Т	April	4		
1994	Е	2006	U	May	5		
1995	F	2007	V	June	6		
1996	Н	2008	W	July	7		
1997	J	2009	Х	August	8		
1998	K	2010	А	September	9		
1999	L	2011	В	October	0		
2000	М	2012	С	November	N		
2001	N	:	:	December	D		
	I	1	1	1	I		

repeats in a 20 year cycle

Factory identification mark

Factory identification Mark	Country of origin	
no mark	Ionon	
	Japan	
	Indonesia	
$\overline{\nabla}$	Philippines	
	China	

* This factory marking is for identification purpose only. Please Contact the local SHARP sales representative to see the actual status of the production.

Rank mark

Refer to the Model Line-up table

■ Absolute Maximum Ratings

	Absolute Maximum Ratings (T _a =25°C						
	Parameter	Symbol	Rating	Unit			
	Forward current	$I_{\rm F}$	10	mA			
Input	*1 Peak forward current	I _{FM}	200	mA			
Inj	Reverse voltage	V _R	6	V			
	Power dissipation	Р	15	mW			
	Collector-emitter voltage	V _{CEO}	*4 80	V			
Output	Emitter-collector voltage	V _{ECO}	6	V			
Out	Collector current	I _C	50	mA			
	Collector power dissipation	P _C	150	mW			
Total power dissipation		P _{tot}	170	mW			
(Operating temperature	T _{opr}	-30 to +100	°C			
Storage temperature		T _{stg}	-40 to +125	°C			
*2 Isolation voltage		V _{iso (rms)}	3.75	kV			
*3 🤆	Soldering temperature	T _{sol}	260	°C			

*1 Pulse width≤100µs, Duty ratio : 0.001 *2 40 to 60%RH, AC for 1 minute, f=60Hz

*3 For 10s

*4 Up to Date code "P9" (September 2002) VCEO : 70V

Electro-optical Characteristics

Electric	ctro-optica	al Chara	acteristi	cs				$(T_a=25^{\circ}C)$
	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward voltage		$V_{\rm F}$	I _F =10mA	_	1.2	1.4	V
Input	Reverse curre	nt	I _R	$V_R=4V$	-	-	10	μΑ
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF
	Collector dark current		I _{CEO}	$V_{CE}=50V, I_{F}=0$	_	_	100	nA
Output	Collector-emitter breakdown voltage		BV _{CEO}	$I_{C}=0.1 \text{mA}, I_{F}=0$	*5 80	-	-	V
	Emitter-collector breakdown voltage		BV _{ECO}	$I_{\rm E}$ =10µA, $I_{\rm F}$ =0	6	_	_	V
	Collector current		I _C	$I_F=0.5$ mA, $V_{CE}=5$ V	0.5	-	2.5	mA
	Collector-emitter saturation voltage		V _{CE (sat)}	$I_F=10mA$, $I_C=1mA$	-	-	0.2	V
	Isolation resistance		R _{ISO}	DC500V, 40 to 60%RH	5×10 ¹⁰	1×10^{11}	_	Ω
Transfer	Floating capacitance		C _f	V=0, f=1MHz	_	0.6	1.0	pF
charac- teristics	Descriptions	Rise time	t _r	V 2V I 2. A D 1000	-	4	18	μs
unsues	Response time	Fall time	t _f	$V_{CE}=2V$, $I_C=2mA$, $R_L=100\Omega$	_	3	18	μs
	Common mode rejection voltage		CMR	$T_a=25^{\circ}C, R_L=470\Omega, V_{CM}=1.5kV(peak)$ $I_F=0mA, V_{CC}=9V, V_{np}=100mV$	10	_	_	kV/µs

*5 Up to Date code "P9" (September 2002) $BV_{CEO} \ge 70V$.

■ Model Line-up

Package	Tap	oing	Rank mark	I _C [mA]
	3 000pcs/reel	750pcs/reel	Kalik Illaik	$(I_F=0.5mA, V_{CE}=5V, T_a=25^{\circ}C)$
	PC367N	PC367NT	with or without	0.5 to 2.5
Model No.	PC367N1	PC367N1T	А	0.75 to 1.5
	PC367N2	PC367N2T	В	1.0 to 2.0

Please contact a local SHARP sales representative to inquire about production status and Lead-Free options.



Fig.1 Test Circuit for Common Mode Rejection Voltae

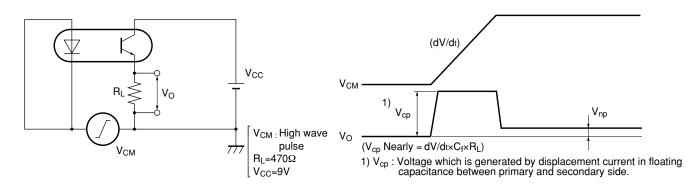


Fig.2 Forward Current vs. Ambient Temperature

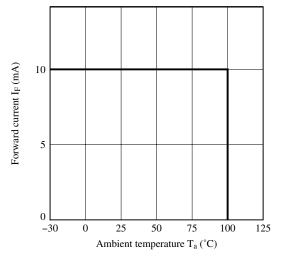


Fig.4 Collector Power Dissipation vs. Ambient Temperature

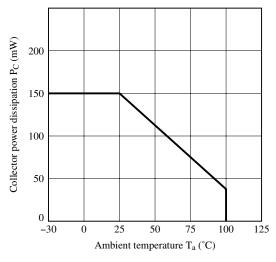
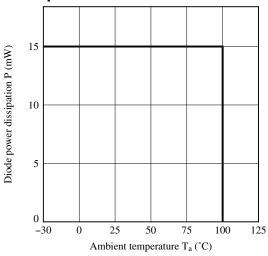
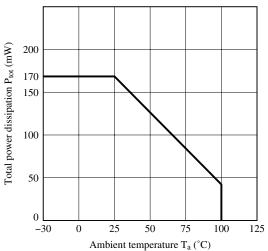


Fig.3 Diode Power Dissipation vs. Ambient Temperature

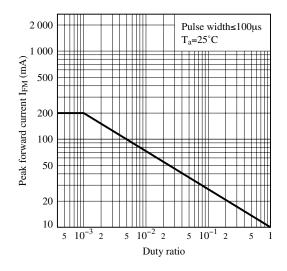




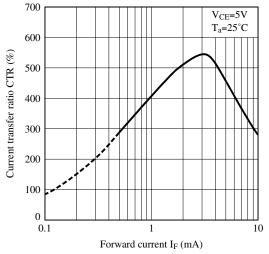


SHARP

Fig.6 Peak Forward Current vs. Duty Ratio









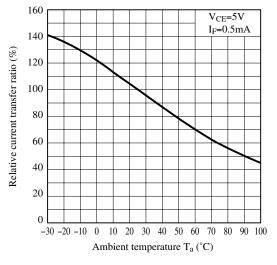


Fig.7 Forward Current vs. Forward Voltage

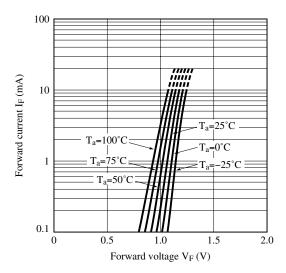


Fig.9 Collector Current vs. Collector-emitter Voltage

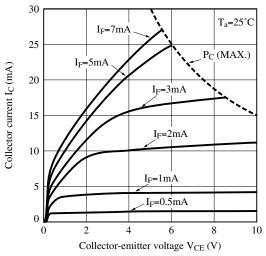


Fig.11 Collector - emitter Saturation Voltage vs. Ambient Temperature

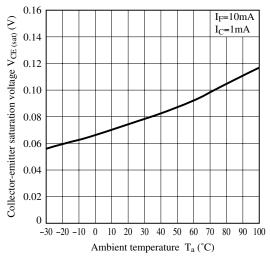
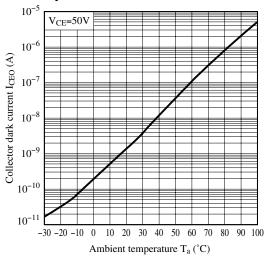
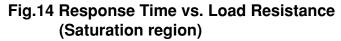
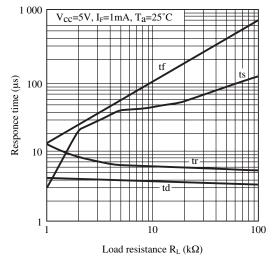




Fig.12 Collector Dark Current vs. Ambient Temperature









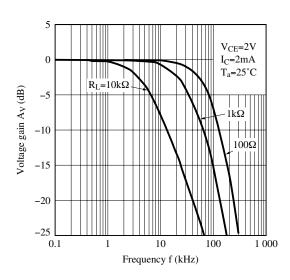


Fig.13 Response Time vs. Load Resistance (Active region)

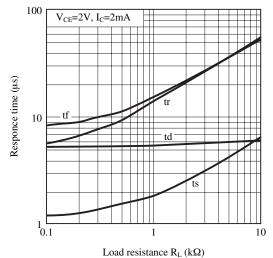
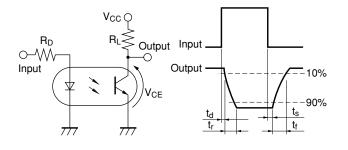
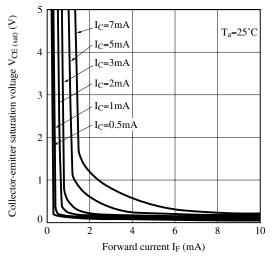


Fig.15 Test Circuit for Response Time



Please refer to the conditions in Fig.13 and Fig.14





Remarks : Please be aware that all data in the graph are just for reference and not for guarantee.



Design Considerations

Design guide

While operating at I_{F} <0.5mA, CTR variation may increase. Please make design considering this fact.

In case that some sudden big noise caused by voltage variation is provided between primary and secondary terminals of photocoupler some current caused by it is floating capacitance may be generated and result in false operation since current may go through IRED or current may change.

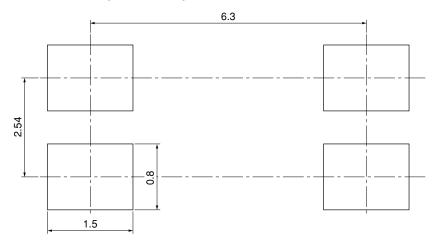
If the photocoupler may be used under the circumstances where noise will be generated we recommend to use the bypass capacitors at the both ends of IRED.

This product is not designed against irradiation and incorporates non-coherent IRED.

Degradation

In general, the emission of the IRED used in photocouplers will degrade over time. In the case of long term operation, please take the general IRED degradation (50% degradation over 5years) into the design consideration.

• Recommended Foot Print (reference)



(Unit : mm)

☆ For additional design assistance, please review our corresponding Optoelectronic Application Notes.

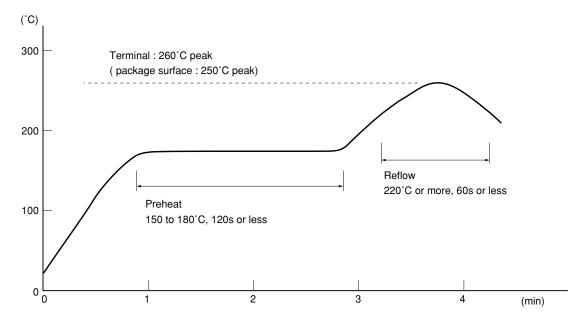


Manufacturing Guidelines

Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below. Soldering should not exceed the curve of temperature profile and time. Please don't solder more than twice.



Flow Soldering :

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 260°C and within 10s. Preheating is within the bounds of 100 to 150°C and 30 to 80s. Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C. Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



• Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below Immersion time should be 3minutes or less

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

• Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances:CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform) Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



Package specification

• Tape and Reel package

1. 3 000pcs/reel

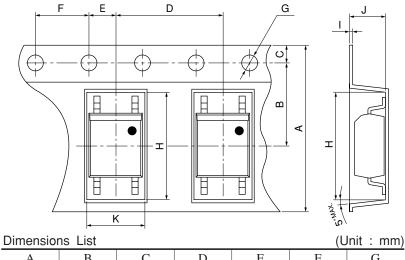
Package materials

Carrier tape : A-PET (with anti-static material)

Cover tape : PET (three layer system)

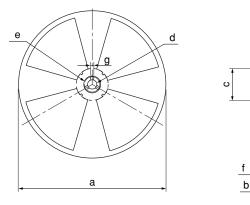
Reel : PS

Carrier tape structure and Dimensions



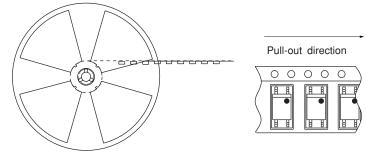
_	А	В	С	D	E	F	G
	$12.0^{\pm 0.3}$	$5.5^{\pm 0.1}$	$1.75^{\pm 0.1}$	$8.0^{\pm0.1}$	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	φ1.5 ^{+0.1}
	Н	Ι	J	K			
	$7.4^{\pm0.1}$	$0.3^{\pm 0.05}$	$3.1^{\pm 0.1}$	$4.0^{\pm 0.1}$			

Reel structure and Dimensions



Dimensio	ns List	(Unit : mm)		
а	b	с	d	
370	13.5 ^{±1.5}	80 ^{±1.0}	13 ^{±0.5}	
e	f	g		
21 ^{±1.0}	$2.0^{\pm 0.5}$	2.0 ^{±0.5}		

Direction of product insertion



[Packing: 3 000pcs/reel]



2. 750 pcs / reel

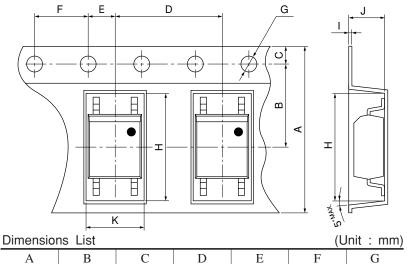
Package materials

Carrier tape : A-PET (with anti-static material)

Cover tape : PET (three layer system)

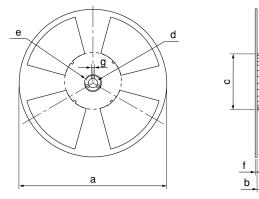
Reel : PS

Carrier tape structure and Dimensions



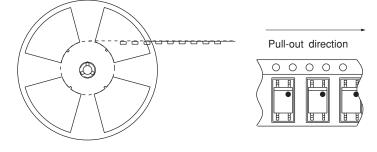
А	В	С	D	Е	F	G
12.0 ^{±0.3}	$5.5^{\pm 0.1}$	$1.75^{\pm 0.1}$	$8.0^{\pm0.1}$	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	φ1.5 ^{+0.1}
Н	Ι	J	K			
$7.4^{\pm 0.1}$	$0.3^{\pm 0.05}$	$3.1^{\pm 0.1}$	$4.0^{\pm0.1}$			

Reel structure and Dimensions



Dimensio	ns List	(Unit : mm)		
а	b	с	d	
180	13.5 ^{±1.5}	80 ^{±1.0}	13 ^{±0.5}	
e	f	g		
21 ^{±1.0}	2.0 ^{±0.5}	2.0 ^{±0.5}		

Direction of product insertion



[Packing : 750pcs/reel]

SHARP

Important Notices

• The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.

• Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.

• Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:

(i) The devices in this publication are designed for use in general electronic equipment designs such as:

- --- Personal computers
- --- Office automation equipment
- --- Telecommunication equipment [terminal]
- --- Test and measurement equipment
- --- Industrial control
- --- Audio visual equipment
- --- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- --- Space applications
- --- Telecommunication equipment [trunk lines]
- --- Nuclear power control equipment
- --- Medical and other life support equipment (e.g., scuba).

• If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Law of Japan, it is necessary to obtain approval to export such SHARP devices.

• This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.

 \cdot Contact and consult with a SHARP representative if there are any questions about the contents of this publication.